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RCE/2800 #

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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Applicants: Mike F. Chang et al.
 Assignee: Siliconix incorporated
 Title: Semiconductor Die Package Including Cup-Shaped Leadframe
 Serial No.: 09/468,249 Filing Date: December 10, 1999
 Examiner: S. Rao Group Art Unit: 2814
 Docket No.: M-7970 US

San Jose, California
 March 27, 2002

BOX RCE
 COMMISSIONER FOR PATENTS
 Washington, D. C. 20231

REQUEST FOR CONTINUED EXAMINATION (RCE)

Dear Sir:

This is a Request for Continued Examination (RCE) under 37 C.F.R. § 1.114 of the above-identified application.

Please consider the Response to Final Office Action and Petition for Extension of Time which accompanies this RCE.

The RCE fee required under 37 C.F.R. § 1.17(e) is authorized in an accompanying transmittal letter.

Please contact the undersigned attorney with any questions concerning this request or the above-identified patent application.

EXPRESS MAIL LABEL NO:

EL 937083 507 US

Respectfully submitted,



Norman R. Klivans
 Attorney for Applicants
 Reg. No. 33,003

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